

General Description

The MAX2112 evaluation kit (EV kit) simplifies the testing and evaluation of the IC direct-conversion tuner. The evaluation kit is fully assembled and tested at the factory. Standard 50Ω SMA and BNC connectors are included on the EV kit for the inputs and outputs to allow quick and easy evaluation on the test bench.

This document provides a list of equipment required to evaluate the device, a straightforward test procedure to verify functionality, a description of the EV kit circuit, the circuit schematic, a component list for the kit, and artwork for each layer of the PCB.

Features

- Easy Evaluation of the MAX2112
- 50Ω RF Input SMA Connector
- 50Ω Baseband Output BNC Connector
- Single 3.3V ±5% Supply
- I²C 2-Wire Serial Interface
- All Critical Peripheral Components Included
- Fully Assembled and Tested
- PC Control Software
(available at www.maximintegrated.com/evkitsoftware)

Ordering Information

PART	TYPE
MAX2112EVKIT+	EV Kit

+Denotes lead(Pb)-free and RoHS compliant.

MAX2112 EV Kit Bill of Materials

DESIGNATION	QTY	DESCRIPTION
ADDR	0	Not installed, 3-pin (1 x 3) inline header, 0.01in centers Sullins PEC36SAAN
BB_I_O/P, BB_Q_O/P	2	50Ω BNC PC mounts Amphenol 31-5329-52RFX
BB_IN, BB_IP, BB_QN, BB_QP, CP_OUT, J12, J13, J17, REF_O/P, VGC	10	PC mini red test points Keystone 5000
C1–C6, C9	7	1000pF ±10% ceramic capacitors (0603) Murata GRM188R71H102K
C7, C13, C19, C20, C75	5	0.1μF ±10% ceramic capacitors (0603) Murata GRM188R71C104K
C8, C12, C25–C30	0	Not installed, capacitors

DESIGNATION	QTY	DESCRIPTION
C10, C11	2	0.047μF ±10% ceramic capacitors (0603) Murata GRM188R71C473K
C14	1	100pF ±5% ceramic capacitor (0603) Murata GRM1885C1H101J
C15	1	0.033μF ±10% ceramic capacitor (0603) Murata GRM188R71E333K
C16	1	2200pF ±5% ceramic capacitor (0603) Murata GRM188R71H222J
C17, C18	2	10μF ±10% tantalum capacitors (C Case) AVX TAJC016K016
C22	1	43.2Ω ±1% resistor (0603)*
C23, C24, C71–C73	5	330pF ±5% ceramic capacitors (0603) Murata GRM1885C1H331J

MAX2112 EV Kit Bill of Materials (continued)

DESIGNATION	QTY	DESCRIPTION
J6	1	DB25 right-angle male connector AMP 5747238-4
JP_VCC, VCC_BB, VCC_DIG, VCC_LO, VCC_RF1, VCC_RF2, VCC_SYN, VCC_VCO	0	Not installed, 2-pin (1 x 2) inline headers, 0.01in centers Sullins PEC36SAAN
L1	1	33pF ±5% capacitor (0603) Murata GRM1885C1H330J
R2, R12, R18–R20, R22, R25, R27–R33	0	Not installed, resistors
R3, R7, R15–R17, R21	6	0Ω ±5% resistors (0603)*
R4, R13, R24	3	1kΩ ±5% resistors (0603)*
R5	1	820Ω ±5% resistor (0603)*
R6	1	390Ω ±5% resistor (0603)*
R8	1	86.6Ω ±1% resistor (0603)*
R9–R11, R41, R42	5	100Ω ±1% resistors (0603)*
R14, R43	2	5.1kΩ ±5% resistors (0603)*
R23, R26	2	0.1μF ±10% ceramic capacitors (0603) Murata GRM188R71C104K
R46, R47	2	2.7kΩ ±5% resistors (0603)*

DESIGNATION	QTY	DESCRIPTION
REF_INPUT	0	Not installed, SMA edge-mount connector, round contact Emerson 142-0701-801
RF_INPUT	1	SMA edge-mount connector, round contact Emerson 142-0701-801
U1	1	DVBS tuner (28 TQFN-EP**) Maxim MAX2112ETI+
U2, U4	0	Not installed, single-supply op amps with R2R outputs Maxim MAX4453ESA
U3	1	74LV07A hex buffer/driver OC TI SN74LV07ADR
U5	0	Not installed, open I/O comparator Maxim MAX985
Y1	1	27MHz crystal Citizen America 300-8571-1-ND Digi-Key HCM49-27.000MABJ-UT
—	0	Not installed, shunts (JP_VCC, VCC_BB, VCC_DIG, VCC_LO, VCC_RF1, VCC_RF2, VCC_SYN, VCC_VCO) Shorting jumpers, 2 position Sullins SSC02SYAN
—	1	PCB: MAX2112/20 EVALUATION KIT+

*Use lead-free parts only.

**EP = Exposed pad.

Component Suppliers

SUPPLIER	WEBSITE
AMP/Tyco Electronics	www.tycoelectronics.com
Amphenol RF	www.amphenolrf.com
AVX Corp.	www.avxcorp.com
Digi-Key Corp.	www.digikey.com
Emerson Network Power	www.emersonnetworkpower.com
Keystone Electronics Corp.	www.keyelco.com
Maxim Integrated Products, Inc.	www.maxim-ic.com
Murata Americas	www.murataamericas.com
Sullins Electronics Corp.	www.sullinselectronics.com
Texas instruments	www.ti.com

Note: Indicate that you are using the MAX2112 when contacting these component suppliers.

Quick Start

Test Equipment Required

- MAX2112 EV kit
- Dual-output power supply capable of supplying up to 3.3V at > 160mA for V_{CC} and 3V at > 50 μ A for V_{GC} gain control voltage
- RF signal generator capable of delivering at least 0dBm of output power at frequencies up to 2.175GHz
- RF spectrum analyzer capable of covering the operating frequency range of the device
- PC laptop or tablet with Microsoft Windows XP®, Windows® 7, 8 OS and a USB port
- USB-A male to USB-B male cable
- US keyboard
- Multichannel digital oscilloscope (optional)
- Network analyzer to measure return loss (optional)
- Ammeter to measure supply current (optional)

Procedure

The EV kit is fully assembled and factory tested. Follow the instructions in the *Connections and Setup* section for proper device evaluation.

Measurement Considerations

The EV kit includes on-board matching circuitry at the MAX2112 RF input to convert the 50 Ω source to a 75 Ω input. Note that the input power to the device must be adjusted to account for the -6dB power loss of the matching resistor network.

Connections and Setup

This section provides a step-by-step guide to testing the basic functionality of the EV kit in UHF mode. **Caution: Do not turn on DC power or RF signal generators until all connections are completed.**

- 1) Verify that all jumpers are in place.
- 2) With its output disabled, connect the DC power supply to VGC set to 0.5V (maximum gain).
- 3) With its output disabled, set the DC power supply to 3.3V. Connect the power supply to the VCC (through an ammeter if desired) and GND terminals on the EV kit. If available, set the current limit to 200mA.
- 4) With its output disabled, set the RF signal generator to a 955MHz frequency at -69dBm to account for the 6dB resistive pad loss. When measuring noise figure, this 6dB must also be accounted for by subtracting 6dB from the measured noise figure, unless the pad has been removed.
- 5) Connect the output of the RF signal generator to the SMA connector labeled RF_INPUT on the evaluation board.
- 6) Connect the PC to the INTF3000 interface board using the USB-A male to USB-B male cable. On INTF3000, place a jumper between pins 1-2 on JU1 (VBUS Pos). Connect the 25-pin connector of the INTF3000 (J4) directly to the 25-pin connector on the EV kit (J6).
- 7) Turn on the 3.3V VCC power supply, followed by the 3V gain-control power supply. The supply current from the 3.3V VCC supply should read approximately 100mA, and the supply current from the 3V VGC should read approximately 50 μ A. Be sure to adjust the power supply to account for any voltage drop across the ammeter.
- 8) Install and run the IC control software. Software is available for download on the Maxim website at www.maximintegrated.com/evkitsoftware.
- 9) Load the default register settings from the control software by clicking **Edit: Load Defaults**. Set ICP = 1 and BBG[3:0] = 1011.
- 10) Connect the output to a spectrum analyzer or an oscilloscope.
- 11) Enable the RF signal generator's output.
- 12) Activate and set the power level of the RF generator to achieve 1V_{p-p} at the baseband BNC connector outputs.
- 13) Check the I/Q outputs.
- 14) Observe the baseband output at 5MHz with 1V_{p-p}.

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Layout Considerations

The EV kit can serve as a guide for PCB layout. Keep RF signal lines as short as possible to minimize losses and radiation. Use controlled impedance on all high-frequency traces. The exposed paddle must be soldered evenly to the board's ground plane for proper operation. Use abundant vias beneath the exposed paddle for maximum heat dissipation. Use abundant ground vias between RF traces to minimize undesired coupling.

To minimize coupling between different sections of the IC, the ideal power-supply layout is a star configuration, which has a large decoupling capacitor at the central V_{CC} node. The V_{CC} traces branch out from this node, with each trace going to separate V_{CC} pins of the IC. Each V_{CC} pin must have a bypass capacitor with a low impedance to ground at the frequency of interest. Do not share ground vias among multiple connections to the PCB ground plane.

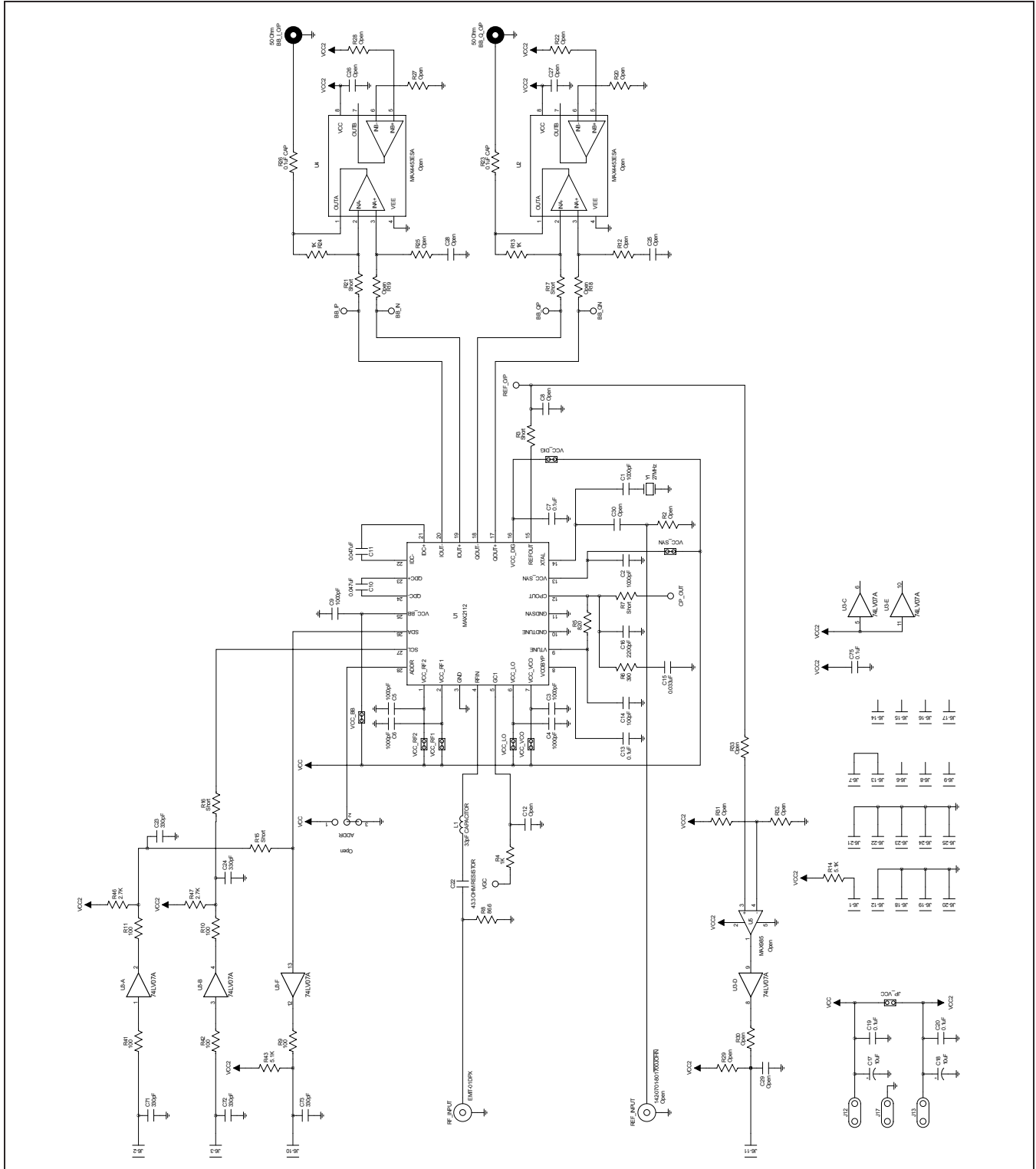


Figure 1. MAX2112 EV Kit Schematic

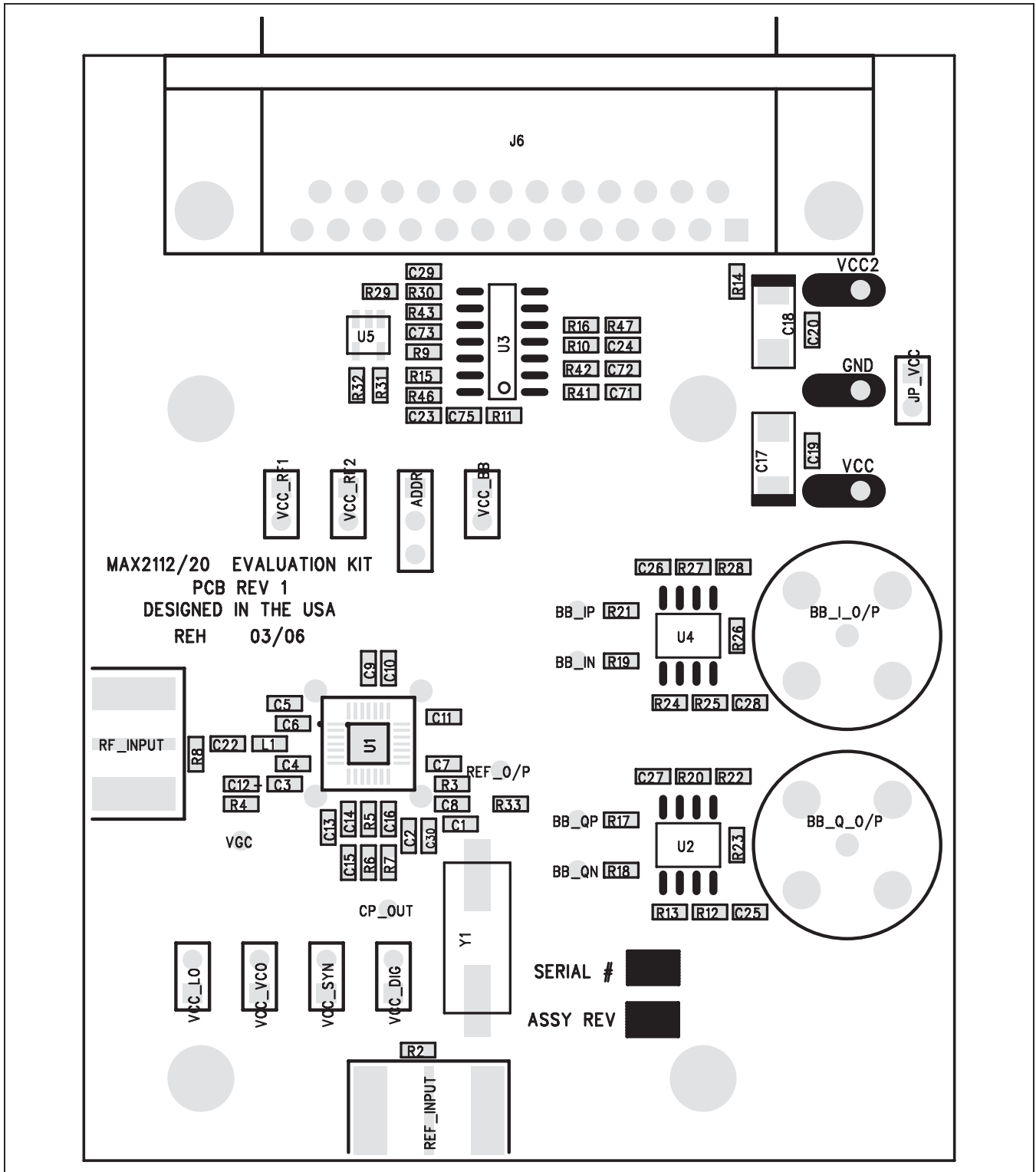


Figure 2. MAX2112 EV Kit PCB Layout—Component Placement Guide

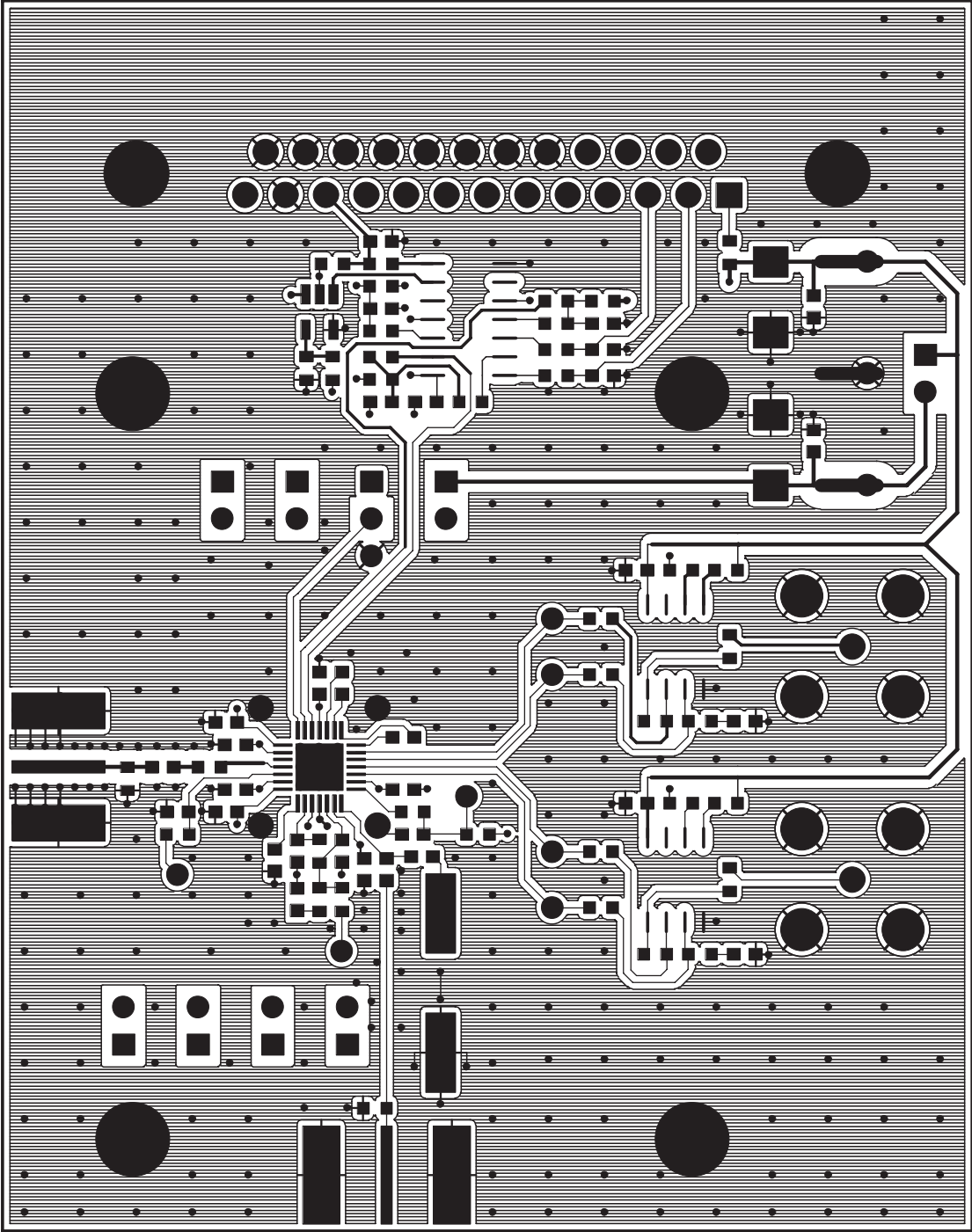


Figure 3. MAX2112 EV Kit PCB Layout—Top

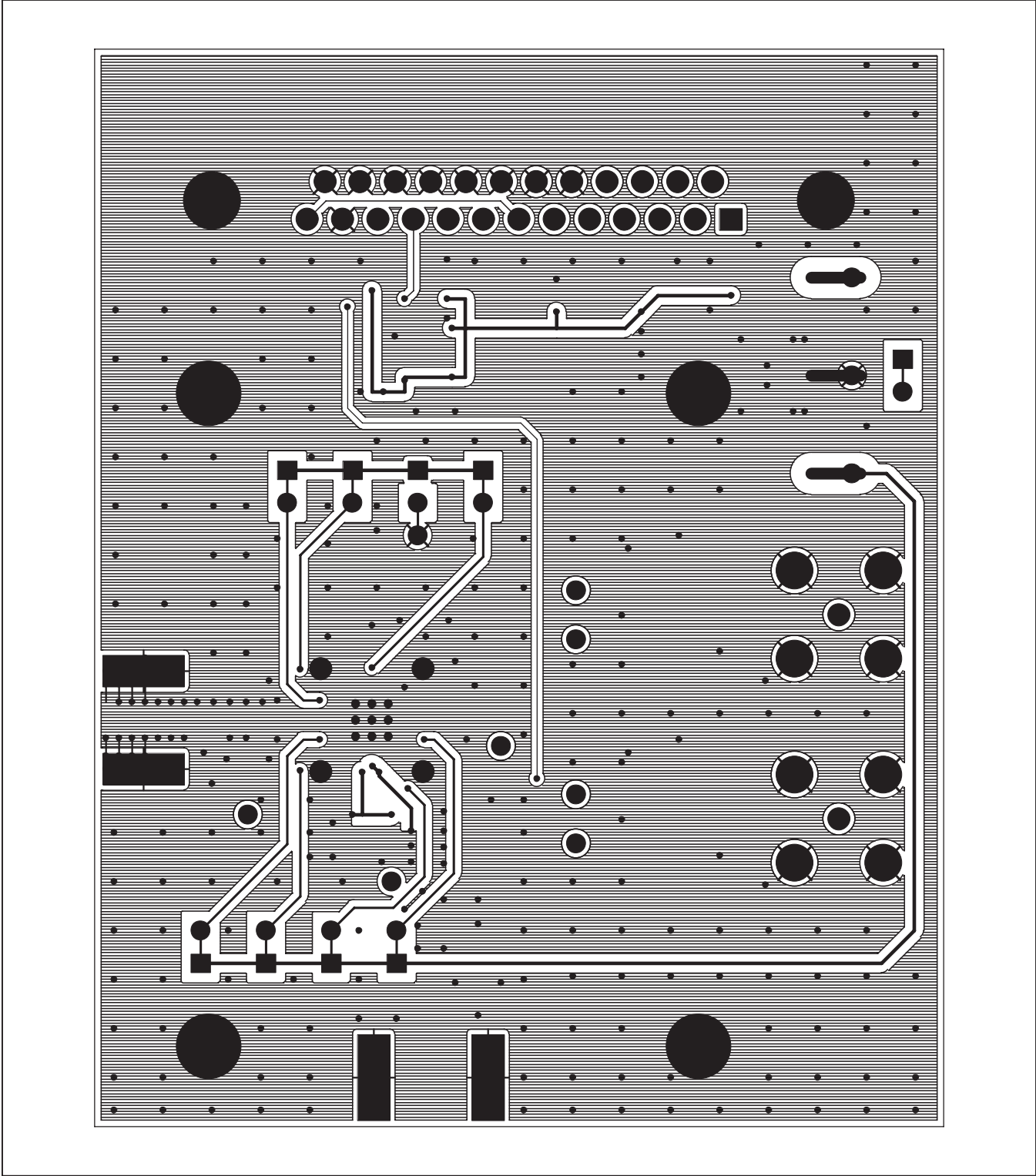


Figure 4. MAX2112 EV Kit PCB Layout—Bottom

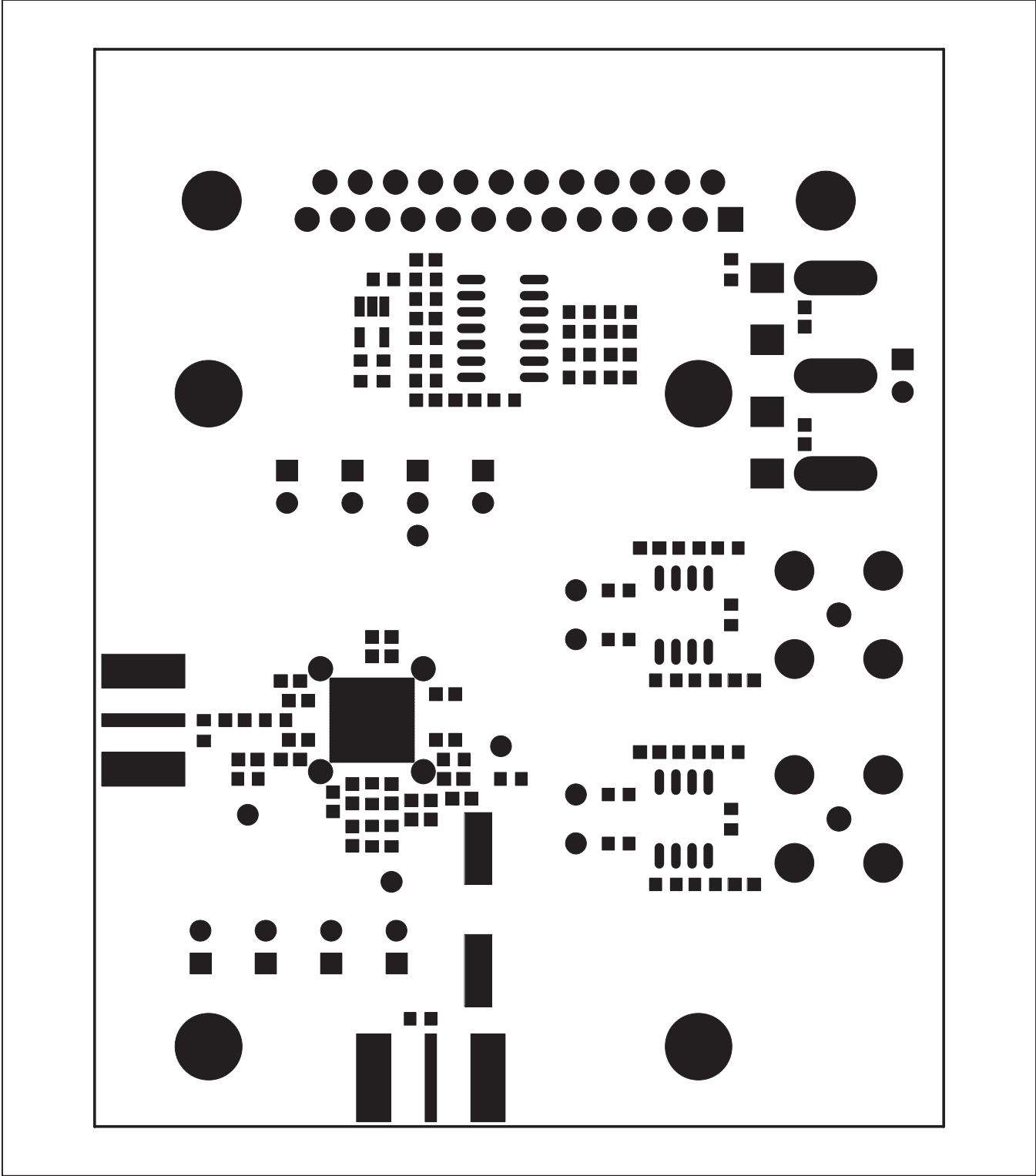


Figure 5. MAX2112 EV Kit PCB Layout—Top Soldermask

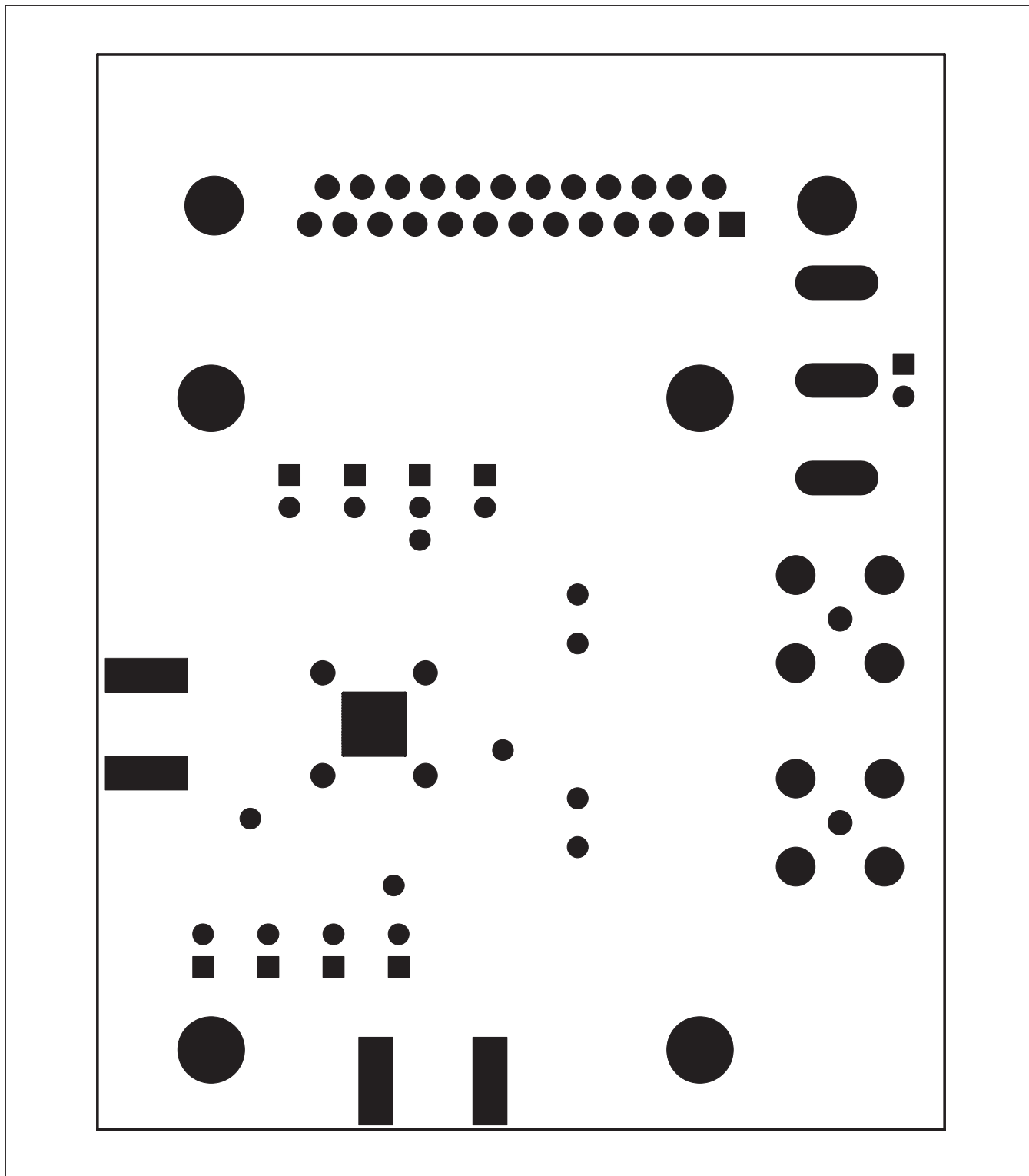


Figure 6. MAX2112 EV Kit PCB Layout—Bottom Soldermask